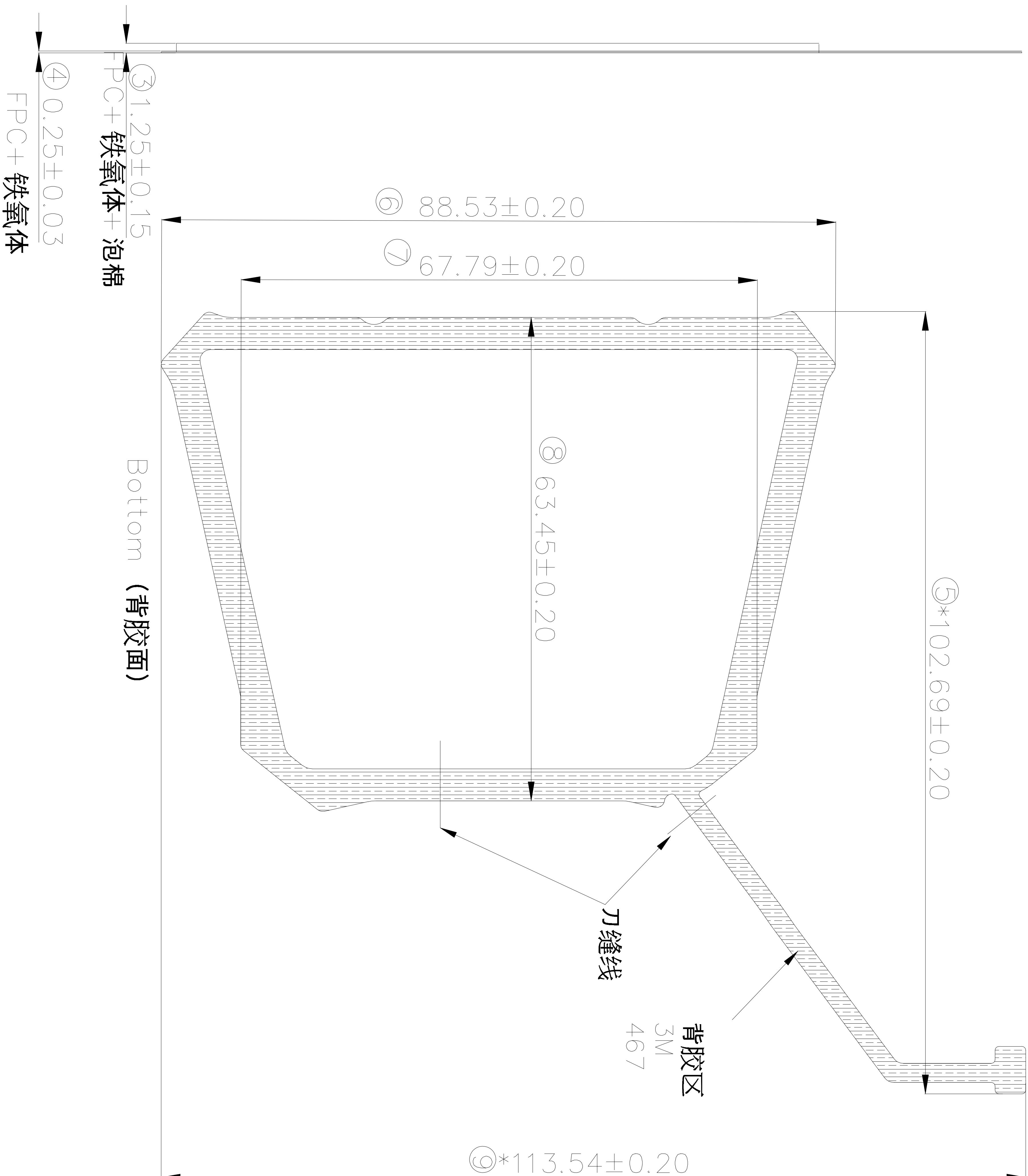
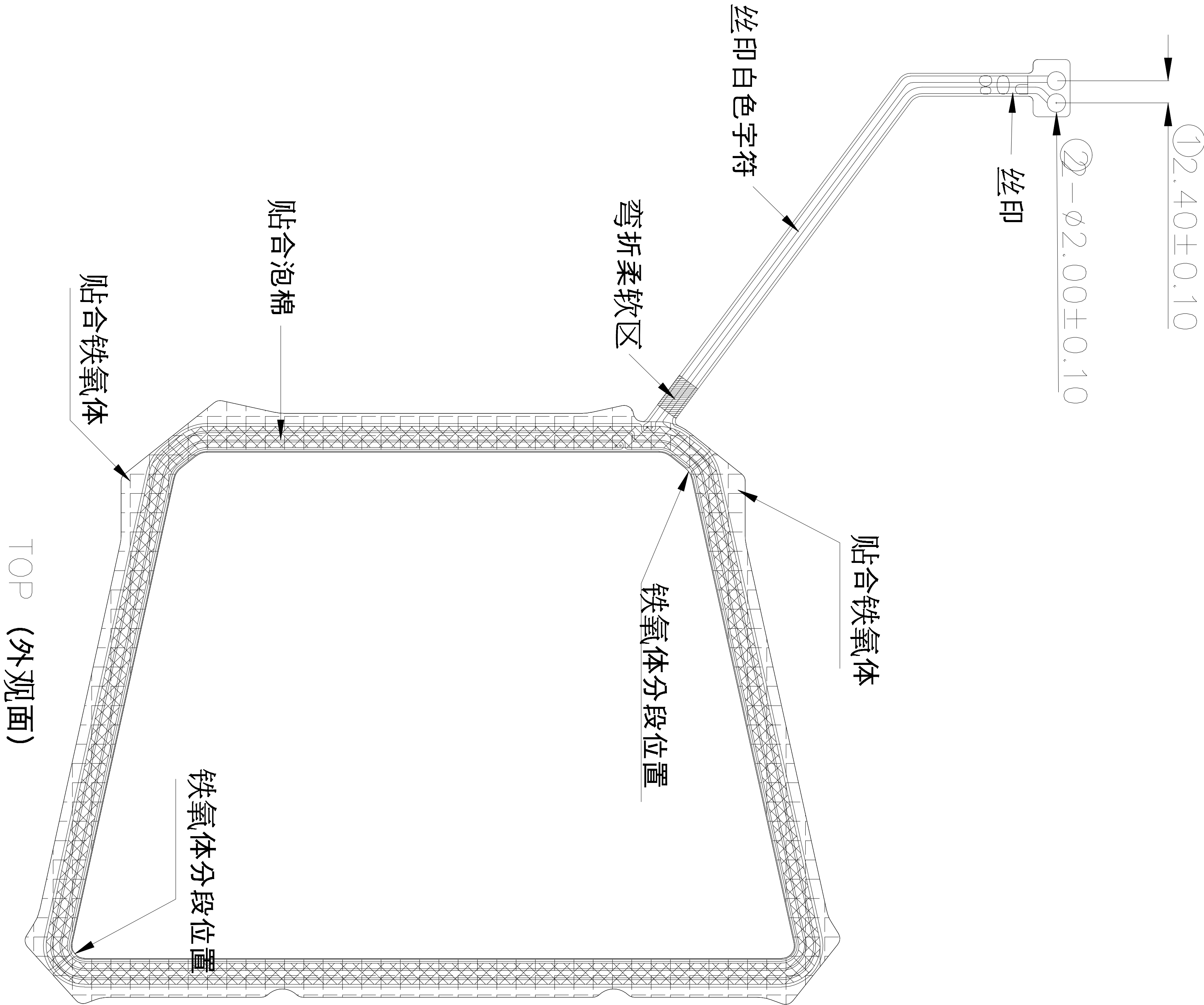


SEQ NO.	REV.NO.	DATE	DESCRIPTION OF CHANGE	ECN NO.	Appr NO.
	2024/09/19		试产		



Notes	FPc+铁氧体外形公差±0.20，铜箔线路公差±0.05，铜箔到外形位置公差±0.15，穿孔外形公差±0.05，孔对孔位置公差±0.10，孔到外形位置公差±0.15. 金手指油墨边界和覆盖膜开窗尺寸公差±0.3.
1. 未注尺寸公差要求	
2. 外观要求	满足德门外观检验标准
3. CPK 测量	标 ST 做CPK; 任意取32PCS产品做CPK.
4. 重点管控尺寸	标“*”为首件重点管控尺寸.
5. ROHS+HF要求	满足德门环境有害物质管控要求
6. 包装要求	自封袋包装或PET微粘膜覆盖包装 (可根据要求)
7. 其他	N/A

DRAWN BY		3rd ANGLE PROJECTION	SIZE	SI	A4	TITLE	NFC 组件			REV.
CHECKED BY(RF)			UNITS	mm		MODEL NAME	P08			
CHECKED BY			SCALE	1:1		DRAWING NUMBER				SHEET
APPROVED BY			TOLERANCES UNLESS OTHERWISE SPECIFIED			CUSTOMER				1 of 1
			*.		±0.05					
			*.		±1.00°					
			ANGULAR	DIMENSION						
			COPYRIGHT: Deman Electronics. 2007. 04. 01							
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